Xinyi Zhang

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EDUCATION

Ph. D. in Engineering 04/2020 – 09/2023

Graduate School of Engineering Science, Osaka University, Japan

Advisor: Prof. Kensuke Harada

Master of Engineering 04/2018 – 03/2020

Graduate School of Engineering Science, Osaka University, Japan

Advisor: Prof. Kensuke Harada

Bachelor 09/2012 - 07/2016

Information Management and Information System, Tianjin University, China

WORK EXPERIENCE

Researcher 10/2023 - Present

Sony R&D

PUBLICATIONS

Journal Paper (Peer-Reviewed)

Xinyi Zhang*, Yukiyasu Domae, Weiwei Wan, Kensuke Harada A Closed-Loop Bin Picking System for Entangled Wire Harnesses using Bimanual and Dynamic Manipulation. 2023. webpage, paper.

- [1] **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Learning to Dexterously Pick or Separate Tangled-Prone Parts for Industrial Bin Picking. IEEE Robotics and Automation Letters (RA-L), 2023. webpage, paper.
- [2] **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Learning a Sequential Policy of Efficient Actions for Tangled-Prone Parts in Robotic Bin Picking. IEEE Robotics and Automation Letters (RA-L), 2022. (Presented at ICRA 2023). webpage, paper.
- [3] Kaidi Nie, Felix von Drigalski, Joshua C. Triyonoputro, Chisato Nakashima, Yoshiya Shibata, Yoshinori Konishi, Yoshihisa Ijiri, Taku Yoshioka, Yukiyasu Domae, Toshio Ueshiba, Ryuichi Takase, **Xinyi Zhang**, Damien Petit, Ixchel G. Ramirez-Alpizar, Weiwei Wan & Kensuke Harada. Team O2AS' approach for the task-board task of the World Robot Challenge 2018. Advanced Robotics, 2020. paper.

International Conferences (Peer-Reviewed)

- [4] Mizuki Takasu, **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Industrial Bin Picking of Potential Entangled Objects in Dense Clutter by Skeletonized Shape Restoration. 18th International Symposium on Experimental Robotics (ISER), 2023.
- [5] **Xinyi Zhang***, Keisuke Koyama, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. A Topological Solution of Entanglement for Complex-shaped Parts in Robotic Bin-picking. IEEE International

Conference on Automation Science and Engineering (CASE), 2021. (IEEE Robotics and Automation Society Japan Joint Chapter Young Award). paper.

Domestic Conferences

- [6] Mizuki Takasu, **Xinyi Zhang**, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Bin-Picking for Potential Entangled Object by Linearing Image of the Pile. SI2022. (Best Presentation Award)
- [7] **Xinyi Zhang**, Weiwei Wan, Yukiyasu Domae, Kensuke Harada. Learning Dexterous Bin Picking Policies for Picking and Separating Tangled-Prone Parts. RSJ2022.
- [8] **Xinyi Zhang**, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Efficiently Picking Tangled-Prone Parts by Learning a Sequential Bin Picking Policy. SICE SI2021. (Best Presentation Award)
- [9] **Xinyi Zhang**, Keisuke Koyama, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Topology-based Grasp Detection Avoiding Entanglement for Robotic Bin-picking. SI2020. (Young Scientist Incentive Award, Best Presentation Award)
- [10] **Xinyi Zhang**, Keisuke Koyama, Weiwei Wan, Yukiyasu Domae, Kensuke Harada. Motion Generation for Separating Tangled Objects in Robotic Bin-picking. SCI'20.
- [11] **Xinyi Zhang**, Damien Petit, Yukiyasu Domae, Ixchel G. Ramirez-Alpizar, Weiwei Wan, Kensuke Harada. Error Analysis and Adjustment on Randomized Bin-picking. SI2019.
- [12] **Xinyi Zhang**, Damien Petit, Yukiyasu Domae, Ixchel G. Ramirez-Alpizar, Weiwei Wan, Kensuke Harada. A Real-time Robotic Calibration Method for Vision-based Bin-picking. ROBOMECH2019.

PATENTS

- [1] 原田研介, **張馨藝 (Xinyi Zhang)**, 堂前幸康, 万偉偉, 森建郎. ワーク取出し装置. 特開 2023-095329, 2023.
- [2] 原田研介, 万偉偉, 堂前幸康, **張馨藝** (Xinyi Zhang), 森建郎, 吹田和嗣, 五十嵐淳. ワーク取り出し装置、ワーク取り出し方法、プログラム及び制御装置. 特開 2021-186542, 2021.

AWARDS AND HONORS

Best Presentation Award (優秀講演賞)	12/2021
SICE SI2021	
Young Scientist Incentive Award (若手奨励賞)	12/2021
SICE SI Division	
Japan Joint Chapter Young Award (IROS, CASE2021)	10/2021
IEEE Robotics and Automation Society	
Scholarship	04/2021 - 03/2023
Kobayashi Foundation (公益財団法人小林財団)	
Best Presentation Award (優秀講演賞)	12/2020
SICE SI2020	